

# MSP430F2132 Device Erratasheet

## 1 Revision History

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev B	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
BCL12	✓	<b>√</b>
BCL13		✓
BCL16	✓	✓
CPU19	✓	<b>✓</b>
EEM20	✓	✓
FLASH19	✓	✓
FLASH24	✓	<b>✓</b>
FLASH27	✓	<b>✓</b>
FLASH36	✓	<b>✓</b>
PORT12	✓	✓
SYS15	✓	✓
TA12	✓	<b>✓</b>
TA16	✓	<b>✓</b>
TA21	✓	✓
TAB22	✓	<b>✓</b>
USCI20	✓	✓
USCI21	✓	✓
USCI22	✓	✓
USCI23	✓	✓
USCI24	✓	✓
USCI25	✓	✓
USCI26	✓	✓
USCI28	✓	✓
USCI30		✓
USCI35	✓	✓
USCI40	✓	✓
XOSC5	✓	✓
XOSC8	✓	✓



Package Markings www.ti.com

## 2 Package Markings

## PW28 TSSOP (PW), 28 Pin



YM = Year and Month Date Code

LLLL = Assembly Lot Code S = Assembly Site Code

# = DIE Revision

o = PIN 1



YM = Year and Month Date Code

LLLL = Assembly Lot Code S = Assembly Site Code

= DIE Revision

o = PIN 1

## RHB32 QFN (RHB), 32 Pin



YM = Year and Month Date Code

LLLL = Assembly Lot Code S = Assembly Site Code # = DIE Revision

o = PIN 1

**Function** 



## 3 Detailed Bug Description

## BCL12 BCS Module

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Switching RSELx or modifying DCOCTL can cause DCO dead time or a complete DCO

stop

**Description** After switching RSELx bits (located in register BCSCTL1) from a value of >13 to a value

of <12 OR from a value of <12 to a value of >13, the resulting clock delivered by the DCO can stop before the new clock frequency is applied. This dead time is approximately 20 us. In some instances, the DCO may completely stop, requiring a

power cycle.

Furthermore, if all of the RSELx bits in the BSCTL1 register are set, modifying the DCOCTL register to change the DCOx or the MODx bits could also result in DCO dead

time or DCO hang up.

Workaround

- When switching RSEL from >13 to <12, use an intermediate frequency step. The intermediate RSEL value should be 13.

Current RSEL	Target RSEL	Recommended Transition Sequence
15	14	Switch directly to target RSEL
14 or 15	13	Switch directly to target RSEL
14 or 15	0 to 12	Switch to 13 first, and then to target RSEL (two step sequence)
0 to 13	0 to 12	Switch directly to target RSEL

### **AND**

- When switching RSEL from <12 to >13 it's recommended to set RSEL to its default value first (RSEL = 7) before switching to the desired target frequency.

### **AND**

- In case RSEL is at 15 (highest setting) it's recommended to set RSEL to its default value first (RSEL = 7) before accessing DCOCTL to modify the DCOx and MODx bits. After the DCOCTL register modification the RSEL bits can be manipulated in an additional step.

In the majority of cases switching directly to intermediate RSEL steps as described above will prevent the occurrence of BCL12. However, a more reliable method can be implemented by changing the RSEL bits step by step in order to guarantee safe function without any dead time of the DCO.

Note that the 3-step clock startup sequence consisting of clearing DCOCTL, loading the BCSCTL1 target value, and finally loading the DCOCTL target value as suggested in the in the "TLV Structure" chapter of the MSP430x2xx Family User's Guide is not affected by BCL12 if (and only if) it is executed after a device reset (PUC) prior to any other modifications being made to BCSCTL1 since in this case RSEL still is at its default value of 7. However any further changes to the DCOx and MODx bits will require the consideration of the workaround outlined above.

### BCL13 BCS Module

Function DCO powerup halt

**Description**When subject to very slow Vcc rise times, the device may enter into a state where the DCO does not oscillate. No JTAG access or program execution is possible and the

device will remain in a reset state until the supply voltage is disconnected.



Workaround Apply a Vcc poweron ramp >= 10V/second under all power-on/power-cycle scenarios.

BCL16 BCS Module

Function SMCLK clock source selection from XT1/VLO to DCO

Description When the MCLK and the SMCLK do not use the DCO, the DCO is off. The DCO does

not start if the clock source for SMCLK is changed from XT1/VLO to DCO. As a result, the SMCLK remains high. Note: This is only true for SMCLK. The DCO starts if the clock

source of MCLK is set to DCO.

Workaround Set clock source of MCLK to DCO by either:

1)setting the selection bits SELMx of BCSCTL2 register to '00' or '01'.

OR

2)setting the OFIFG bit of IFG1 register. Note: This triggers the oscillator fault logic that

automatically starts the DCO. Reset the OFIFG bit to further use the XT1/VLO.

For both options, if the XT1/VLO is still required to source MCLK, revert the clock source

of MCLK back to XT1/VLO afterwards.

CPU19 CPU Module

Function CPUOFF modification may result in unintentional register read

**Description** If an instruction that modifies the CPUOFF bit in the Status Register is followed by an

instruction with an indirect addressed operand (e.g. MOV @R8, R9, RET, POP, POPM), an unintentional register read operation can occur during the wakeup of the CPU. If the unintentional read occurs to a read sensitive register (e.g. UCB0RXBUF, TAIV), which changes its value or the value of other registers (IFG's), the bug leads to lost interrupts

or wrong register read values.

**Workaround** Insert a NOP instruction after each CPUOFF instruction.

OR

Refer to the table below for compiler-specific fix implementation information.

Note that compilers implementing the fix may lead to double stack usage when

RET/RETA follows the compiler-inserted NOP.

IDE/Compiler	Version Number	Notes
IAR Embedded Workbench	IAR EW430 v6.20.1 until v6.40	User is required to add the compiler or assembler flag option belowhw_workaround=nop_after_lpm
IAR Embedded Workbench	IAR EW430 v6.40 or later	Workaround is automatically enabled
TI MSP430 Compiler Tools (Code Composer Studio)	15.12.0.LTS	User is required to add the compiler or assembler flag option belowsilicon_errata=CPU19
MSP430 GNU Compiler (MSP430-GCC)	MSP430-GCC 4.9 build 389 or later	User is required to add the compiler or assembler flag option belowmsilicon-errata=cpu19 -msilicon-errata-warn=cpu19 generates a warning in addition





IDE/Compiler	Version Number	Notes	
MSP430 GNU Compiler (MSP430-GCC)	MSP430-GCC 5.x build 14 or later	User is required to add the compiler or assembler flag option belowmsilicon-errata=cpu19 -msilicon-errata-warn=cpu19 generates a warning in addition	

**EEM20 EEM Module** 

**Function** Debugger might clear interrupt flags

During debugging read-sensitive interrupt flags might be cleared as soon as the Description

debugger stops. This is valid in both single-stepping and free run modes.

Workaround None.

FLASH19 FLASH Module

**Function** EEI feature does not work for code execution from RAM

When the program is executed from RAM, the flash controller EEI feature does not work. Description

The erase cycle is suspended and the interrupt is serviced, but there is a problem while

resuming with the erase cycle.

Addresses applied to flash are different than the actual values while resuming erase

cycle after ISR execution.

Workaround None

FLASH24 **FLASH Module** 

**Function** Write or erase emergency exit can cause failures

When a flash write or erase is abruptly terminated, the following flash accesses by the Description CPU may be unreliable resulting in erroneous code execution. The abrupt termination

can be the result of one the following events:

1) The flash controller clock is configured to be sourced by an external crystal. An

oscillator fault occurs thus stopping this clock abruptly.

2) The Emergency Exit bit (EMEX in FCTL3) when set forces a write or an erase

operation to be terminated before normal completion.

3) The Enable Emergency Interrupt Exit bit (EEIEX in FCTL1) when set with GIE=1 can

lead to an interrupt causing an emergency exit during a Flash operation.

1) Use the internal DCO as the flash controller clock provided from MCLK or SMCLK. Workaround

or

2) After setting EMEX = 1, wait for a sufficient amount of time before Flash is accessed

again.

or



3) No Workaround. Do not use EEIEX bit.

### FLASH27 FLASH Module

Function EEI feature can disrupt segment erase

**Description** When a flash segment erase operation is active with EEI feature selected (EEI=1 in

FLCTL1) and GIE=0, the following can occur:

An interrupt event causes the flash erase to be stopped, and the flash controller expects an RETI to resume the erase. Because GIE=0, interrupts are not serviced and RETI will

never happen.

Workaround 1) Do not set bit EEI=1 when GIE=0.

or,

2) Force an RETI instruction during the erase operation during the check for BUSY=1

(FCLTL3).

Sample code:

MOV R5, 0(R5); Dummy write, erase segment

LOOP: BIT #BUSY, &FCTL3; test busy bit JMP SUB\_RETI; Force RETI instruction

JNZ LOOP; loop while BUSY=1

SUB\_RETI: PUSH SR

**RETI** 

## FLASH36 FLASH Module

**Function** Flash content may degrade due to aborted page erases

**Description** If a page erase is aborted by EEIEX, the flash page containing the last instruction before

erase operation will start to degrade. This effect is incremental and, after repetitions,

may lead to corrupted flash content.

Use the EEI (interrupted erasing) feature instead of EEIEX (abort erasing).

or

- A PSA checksum can be calculated over affected flash page using the marginal read mode (marginal 0). If PSA sum differs from expected PSA value the affected flash page

has to be reprogrammed.

or

- Start flash erasing from RAM and limit system frequency to <1MHz (to ensure 6-us delay after EEIEX). If the last instruction before erasing is located in RAM, flash cell degradation does not occur.

3 .....

## PORT12 PORT Module

Function PxIFG is set on PUC

**Description** The PxIN register is cleared when a PUC is asserted, and it regains the original value

after the PUC is de-asserted. If the PxIN register bits read high, asserting a PUC causes clearing of the register, which results in a high-to-low transition. Once the PUC is de-



asserted, the PxIN register is restored to high, which results in a low-to-high transition.

This behavior results in the PxIFG being set regardless of the PxIES setting.

Prior to setting PxIE bits ensure that corresponding PxIFG bits are cleared. Workaround

**SYS15** SYS Module

LPM3 and LPM4 currents exceed specified limits **Function** 

LPM3 and LPM4 currents may exceed specified limits if the SMCLK source is switched Description

from DCO to VLO or LFXT1 just before the instruction to enter LPM3 or LPM4 mode.

After clock switching, a delay of at least four new clock cycles (VLO or LFXT1) must be Workaround

implemented to complete the clock synchronization before going into LPM3 or LPM4.

**TA12** TIMER A Module

**Function** Interrupt is lost (slow ACLK)

Description Timer\_A counter is running with slow clock (external TACLK or ACLK)compared to

> MCLK. The compare mode is selected for the capture/compare channel and the CCRx register is incremented by one with the occurring compare interrupt (if TAR = CCRx). Due to the fast MCLK the CCRx register increment (CCRx = CCRx+1) happens before the Timer A counter has incremented again. Therefore the next compare interrupt should happen at once with the next Timer\_A counter increment (if TAR = CCRx + 1).

This interrupt gets lost.

Workaround Switch capture/compare mode to capture mode before the CCRx register increment.

Switch back to compare mode afterwards.

**TA16** TIMER A Module

**Function** First increment of TAR erroneous when IDx > 00

The first increment of TAR after any timer clear event (POR/TACLR) happens Description

immediately following the first positive edge of the selected clock source (INCLK, SMCLK, ACLK or TACLK). This is independent of the clock input divider settings (ID0, ID1). All following TAR increments are performed correctly with the selected IDx settings.

None Workaround

**TA21** TIMER\_A Module

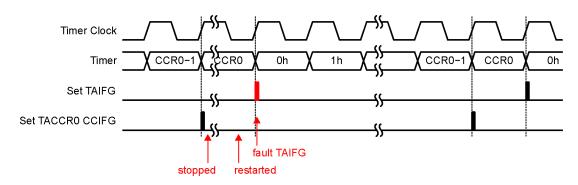
**Function** TAIFG Flag is erroneously set after Timer A restarts in Up Mode

In Up Mode, the TAIFG flag should only be set when the timer counts from TACCR0 to Description

zero. However, if the Timer A is stopped at TAR = TACCR0, then cleared (TAR=0) by setting the TACLR bit, and finally restarted in Up Mode, the next rising edge of the

TACLK will erroneously set the TAIFG flag.





Workaround

None.

## TAB22 TIMER A/TIMER B Module

**Function** 

Timer\_A/Timer\_B register modification after Watchdog Timer PUC

Description

Unwanted modification of the Timer\_A/Timer\_B registers TACTL/TBCTL and TAIV/TBIV can occur when a PUC is generated by the Watchdog Timer(WDT) in Watchdog mode and any Timer\_A/Timer\_B counter register TACCRx/TBCCRx is incremented/decremented (Timer A/Timer B does not need to be running).

Workaround

Initialize TACTL/TBCTL register after the reset occurs using a MOV instruction (BIS/BIC may not fully initialize the register). TAIV/TBIV is automatically cleared following this initialization.

Example code:

MOV.W #VAL, &TACTL

or

MOV.W #VAL, &TBCTL

Where, VAL=0, if Timer is not used in application otherwise, user defined per desired function.

#### USCI20 USCI Module

**Function** 

I2C Mode Multi-master transmitter issue

Description

When configured for I2C master-transmitter mode, and used in a multi-master environment, the USCI module can cause unpredictable bus behavior if all of the following four conditions are true:

1 - Two masters are generating SCL

And

2 - The slave is stretching the SCL low phase of an ACK period while outputting NACK on SDA

And

3 - The slave drives ACK on SDA after the USCI has already released SCL, and then the SCL bus line gets released

And



4 - The transmit buffer has not been loaded before the other master continues communication by driving SCL low

The USCI will remain in the SCL high phase until the transmit buffer is written. After the transmit buffer has been written, the USCI will interfere with the current bus activity and may cause unpredictable bus behavior.

#### Workaround

1 - Ensure that slave doesn't stretch the SCL low phase of an ACK period

Or

2 - Ensure that the transmit buffer is loaded in time

Or

3 - Do not use the multi-master transmitter mode

## USCI21

## **USCI** Module

#### **Function**

UART IrDA receive filter

## Description

The IrDA receive filter can be used to filter pulses with length UCAIRRXFL configured in UCAXIRRCTL register. If UCIRRXFE is set the IrDA receive decoder may filter out pulses longer than the configured filter length depending on frequency of BRCLK. This is resulting in framing errors or corrupted data on the receiver side.

#### Workaround

Depending on the used baud rate and the configured filter length a maximum frequency for BRCLK needs to be set to avoid this issue:

For baud rates equal and higher than 115.000 the maximum allowed BRCLK frequency is equal to the max specified system frequency.

Max BRCLK = 
$$\frac{\text{Filter Length} + 64}{2} \times \frac{\text{Baud Rate} \times 16}{3 \times 10^6}$$



Baud Rate	Filter Length UCIRRXFL (dec)	Max BRCLK (MHz)
	64	3.28
	32	2.46
9600	16	2.05
	8	1.84
9000	4	1.74
	2	1.69
	1	1.66
	0	1.64
	64	6.55
	32	4.92
	16	4.1
40000	8	3.69
19200	4	3.48
	2	3.38
	1	3.33
	0	3.28
	64	13.11
	32	9.83
	16	8.19
38400	8	7.37
30400	4	6.96
	2	6.76
	1	6.66
	0	6.55
56000	64	19.11
	32	14.34
	16	11.95
	8	10.75
	4	10.15
	2	9.86
	1	9.71
	0	9.56

### USCI22 USCI Module

**Function** 

I2C Master Receiver with 10-bit slave addressing

Description

Unexpected behavior of the USCI\_B can occur when configured in I2C master receive mode with 10-bit slave addressing under the following conditions:

- 1) The USCI sends first byte of slave address, the slave sends an ACK and when second address byte is sent, the slave sends a NACK.
- 2) Master sends a repeat start condition (If UCTXSTT=1).
- 3) The first address byte following the repeated start is acknowledged.

However, the second address byte is not sent, instead the Master incorrectly starts to



receive data and sets UCBxRXIFG=1.

Workaround Do not use repeated start condition instead set the stop condition UCTXSTP=1 in the

NACK ISR prior to the following start condition (USTXSTT=1).

USCI23 USCI Module

**Function** UART transmit mode with automatic baud rate detection

**Description** Erroneous behavior of the USCI\_A can occur when configured in UART transmit mode

with automatic baud rate detection. During transmission if a "Transmit break" is initiated (UCTXBRK=1), the USCI\_A will not deliver a stop bit of logic high, instead, it will send a

logic low during the subsequent synch period.

Workaround 1) Follow User's Guide instructions for transmitting a break/synch field following

ÚCSWRST=1.

Or,

2) Set UCTXBRK=1 before an active transmission, i.e. check for bit UCBUSY=0 and

then set UCTXBRK=1.

USCI24 USCI Module

Function Incorrect baud rate information during UART automatic baud rate detection mode

**Description** Erroneous behavior of the USCI\_A can occur when configured in UART mode with

automatic baud rate detection. After automatic baud rate measurement is complete, the UART updates UCAxBR0 and UCAxBR1. Under Oversampling mode (UCOS16=1), for baud rates that should result in UCAxBRx=0x0002, the UART incorrectly reports it as

UCAxBRx=0x5555.

Workaround When break/synch is detected following the automatic baud rate detection, the flag

UCBRK flag is set to 1. Check if UCAxBRx=0x5555 and correct it to 0x0002.

USCI25 USCI Module

Function TXIFG is not reset when NACK is received in I2C mode

**Description** When the USCI\_B module is configured as an I2C master transmitter the TXIFG is not

reset after a NACK is received if the master is configured to send a restart (UCTXSTT=1

& UCTXSTP=0).

Workaround Reset TXIFG in software within the NACKIFG interrupt service routine

USCI26 USCI Module

Function Tbuf parameter violation in I2C multi-master mode

**Description** In multi-master I2C systems the timing parameter Tbuf (bus free time between a stop

condition and the following start) is not guaranteed to match the I2C specification of 4.7us in standard mode and 1.3us in fast mode. If the UCTXSTT bit is set during a running I2C transaction, the USCI module waits and issues the start condition on bus

release causing the violation to occur.

Note: It is recommended to check if UCBBUSY bit is cleared before setting



UCTXSTT=1.

#### Workaround

None

## USCI28

#### **USCI Module**

#### **Function**

Timing of USCI I2C interrupts may cause device reset due to automatic clear of an IFG.

#### Description

When certain USCI I2C interrupt flags (IFG) are set and an automatic flag-clearing event on the I2C bus occurs, it results in an errant ISR call to the reset vector. This will only happen when the IFG is cleared within a critical time window (~6 CPU clock cycles) after a USCI interrupt request occurs and before the interrupt servicing is initiated. The affected interrupts are UCBxTXIFG, UCSTPIFG, UCSTTIFG and UCNACKIFG.

The automatic flag-clearing scenarios are described in the following situations:

- (1) A pending UCBxTXIFG interrupt request is cleared on the falling SCL clock edge following a NACK.
- (2) A pending UCSTPIFG, UCSTTIFG, or UCNACKIFG interrupt request is cleared by a following Start condition.

### Workaround

(1) Polling the affected flags instead of enabling the interrupts.

or

(2) Ensuring the above mentioned flag-clearing events occur after a time delay of 6 CPU clock cycles has elapsed since the interrupt request occurred and was accepted.

or

(3) At program start, check any applicable enabled IE bits such as UCBxTXIE, UCBxRXIE, UCSTTIE, UCSTPIE or UCNACKIE for a reset (A PUC will clear all of the IE bits of interest). If no PUC occurred then the device ran into the above mentioned errant condition and the program counter will need to be restored using an RETI instruction.

; ------ Workaround (3) example for TXIFG ------

Note: For assembly code use code snippet shown below and insert prior to user code main

bit.b #UCBxTXIE ,&IE2; if TXIE is set, errant call occurred

jz start\_normal; if not start main program

reti; else return from interrupt call

start normal

...; Application code continues

Note: For C code the workaround will need to be executed prior to the CSTARTUP routine. The steps for modifying the CSTARTUP routine are IDE dependent.

Examples for Code Composer and IAR Embedded Workbench are shown below.

#### IAR Embedded Workbench:

- 1) The file cstartup.s43 is found at: ...\IAR Systems\<Current Embedded Workbench Version>\430\src\lib\430
- 2) Create a local copy of this file and link it to the project. Do not rename the file.
- 3) In the copy insert the following code prior to stack pointer initialization as shown:

#define IE2 (0x0001)



```
BIT.B #0x08,&IE2; if TXIE is set, errant call occurred
JZ Start Normal; if not start main program
RETI; else return from interrupt call
// Initialize SP to point to the top of the stack.
Start_Normal
MOV #SFE(CSTACK), SP
// Ensure that main is called.
Code Composer:
1) The file boot.c is found at ...\Texas Instruments\<Current Code Composer Version>
\tools\compiler\MSP430\lib\rtssrc.zip
2) Extract the file from rtssrc.zip and create a local copy. Link the copy to the project. Do
not rename this file.
3) In the copy insert the following code prior to stack pointer initialization as shown:
asm("\t BIT.B\t #0x08,&0x0001"); // if TXIE is set, errant call occurred
__asm("\t JZ\t Start_Normal"); // if not start main program
__asm("\t RETI"); // else return from interrupt call
__asm("Start_Normal");
/*_____*/
/* Initialize stack pointer. Stack grows toward lower memory. */
/*-----*/
Insert the code here:
/* C INT00() - C ENVIRONMENT ENTRY POINT */
#pragma CLINK(_c_int00)
extern void __interrupt _c_int00()
// <-- INSERT USCI28 WORKAROUND HERE
STACK INIT();
```

## USCI30

## **USCI** Module

**Function** 

I2C mode master receiver / slave receiver

**Description** 

When the USCI I2C module is configured as a receiver (master or slave), it performs a double-buffered receive operation. In a transaction of two bytes, once the first byte is moved from the receive shift register to the receive buffer the byte is acknowledged and the state machine allows the reception of the next byte.

If the receive buffer has not been cleared of its contents by reading the UCBxRXBUF register while the 7th bit of the following data byte is being received, an error condition may occur on the I2C bus. Depending on the USCI configuration the following may occur:

1) If the USCI is configured as an I2C master receiver, an unintentional repeated start condition can be triggered or the master switches into an idle state (I2C communication



aborted). The reception of the current data byte is not successful in this case.

2) If the USCI is configured as I2C slave receiver, the slave can switch to an idle state stalling I2C communication. The reception of the current data byte is not successful in this case. The USCI I2C state machine will notify the master of the aborted reception with a NACK.

Note that the error condition described above occurs only within a limited window of the 7th bit of the current byte being received. If the receive buffer is read outside of this window (before or after), then the error condition will not occur.

#### Workaround

a) The error condition can be avoided altogether by servicing the UCBxRXIFG in a timely manner. This can be done by (a) servicing the interrupt and ensuring UCBxRXBUF is read promptly or (b) Using the DMA to automatically read bytes from receive buffer upon UCBxRXIFG being set.

#### OR

b) In case the receive buffer cannot be read out in time, test the I2C clock line before the UCBxRXBUF is read out to ensure that the critical window has elapsed. This is done by checking if the clock line low status indicator bit UCSCLLOW is set for atleast three USCI bit clock cycles i.e. 3 X t(BitClock).

Note that the last byte of the transaction must be read directly from UCBxRXBUF. For all other bytes follow the workaround:

Code flow for workaround

- (1) Enter RX ISR for reading receiving bytes
- (2) Check if UCSCLLOW.UCBxSTAT == 1
- (3) If no, repeat step 2 until set
- (4) If yes, repeat step 2 for a time period  $> 3 \times t$  (BitClock) where t (BitClock) = 1/f (BitClock)
- (5) If window of 3 x t(BitClock) cycles has elapsed, it is safe to read UCBxRXBUF

#### USCI35 USCI Module

Function

Violation of setup and hold times for (repeated) start in I2C master mode

Description

In I2C master mode, the setup and hold times for a (repeated) START,  $t_{\text{SU,STA}}$  and  $t_{\text{HD,STA}}$  respectively, can be violated if SCL clock frequency is greater than 50kHz in standard mode (100kbps). As a result, a slave can receive incorrect data or the I2C bus can be stalled due to clock stretching by the slave.

Workaround

If using repeated start, ensure SCL clock frequencies is < 50kHz in I2C standard mode (100 kbps).

## USCI40 USCI Module

**Function** 

SPI Slave Transmit with clock phase select = 1

Description

In SPI slave mode with clock phase select set to 1 (UCAxCTLW0.UCCKPH=1), after the first TX byte, all following bytes are shifted by one bit with shift direction dependent on UCMSB. This is due to the internal shift register getting pre-loaded asynchronously when writing to the USCIA TXBUF register. TX data in the internal buffer is shifted by one bit after the RX data is received.

Workaround

Reinitialize TXBUF before using SPI and after each transmission.



If transmit data needs to be repeated with the next transmission, then write back previously read value:

UCAxTXBUF = UCAxTXBUF;

XOSC5 XOSC Module

**Function** LF crystal failures may not be properly detected by the oscillator fault circuitry

**Description** The oscillator fault error detection of the LFXT1 oscillator in low frequency mode (XTS =

0) may not work reliably causing a failing crystal to go undetected by the CPU, i.e.

OFIFG will not be set.

Workaround None

XOSC8 XOSC Module

**Function** ACLK failure when crystal ESR is below 40 kOhm.

**Description** When ACLK is sourced by a low frequency crystal with an ESR below 40 kOhm, the duty

cycle of ACLK may fall below the specification; the OFIFG may become set or in some

instances, ACLK may stop completely.

Workaround Please refer to "XOSC8 Guidance" found at SLAA423 for information regarding working

with this erratum.



## 4 Document Revision History

Changes from family erratasheet to device specific erratasheet.

- 1. Errata FLASH36 was added
- 2. Errata SYS15 was added

Changes from device specific erratasheet to document Revision A.

1. Errata EEM20 was added to the errata documentation.

Changes from document Revision A to Revision B.

1. BCL12 Workaround was updated.

Changes from document Revision B to Revision C.

1. Errata TA21 was added to the errata documentation.

Changes from document Revision C to Revision D.

1. Errata USCI35 was added to the errata documentation.

Changes from document Revision D to Revision E.

- 1. Errata BCL16 was added to the errata documentation.
- 2. Silicon Revision C was added to the errata documentation.

Changes from document Revision E to Revision F.

Changes from document Revision F to Revision G.

1. Package Markings section was updated.

Changes from document Revision G to Revision H.

1. Errata USCI40 was added to the errata documentation.

Changes from document Revision H to Revision I.

1. TA21 Description was updated.

Changes from document Revision I to Revision J.

1. USCI28 Workaround was updated.

Changes from document Revision J to Revision K.

1. Workaround for CPU19 was updated.

#### IMPORTANT NOTICE

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